APPENDIX B AND C



Telson Electronics USA, Inc.., Model No: TDC-8200 FCC ID: MC6TDC8200

APPENDIX B - E-Field Probe Calibration Data

See attached.

1365 Adams Court, Menlo Park, CA 94025

Date of Test: April 14 to 17, 2003



Telson Electronics USA, Inc.., Model No: TDC-8200 FCC ID: MC6TDC8200

Date of Test: April 14 to 17, 2003

Zeughausstrasse 43, 8004 Zurich, Switzerla	nd, Phone +41 1 245 97 00, Fax +41 1 245 97
Calibratio	n Certificate
	E-Field Probe
Туре:	ET3DV6
Serial Number:	1576
Place of Calibration:	Zurich
Date of Calibration:	February 27, 2002
Calibration Interval:	12 months
	ertifies, that this device has been calibrated on s performed in accordance with specifications ering AG.
Wherever applicable, the standards used in the international standards. In all other cases the Microwave Electronics at the Swiss Federal Switzerland have been applied.	standards of the Laboratory for EMF and
Calibrated by:	Alusic Katy -
Approved by:	X/Vela



Telson Electronics USA, Inc.., Model No: TDC-8200 FCC ID: MC6TDC8200 Date of Test: April 14 to 17, 2003

Schmid & Partner Engineering AG

Zeughausstrasse 43, 8004 Zurich, Switzerland, Telephone +41 1 245 97 00, Fax +41 1 245 97 79

Probe ET3DV6

SN:1576

Manufactured: Last calibration: Recalibrated: April 6, 2001 April 20, 2001 February 27, 2002

Calibrated for System DASY3

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ET3DV6 SN:1576

February 27, 2002

DASY3 - Parameters of Probe: ET3DV6 SN:1576

Sensitivity in Free Space

Diode Compression

NormX	1.77 μV/(V/m) ²	DCP X	98	mV
NormY	1.81 μV/(V/m) ²	DCP Y	98	mV
NormZ	1.76 µV/(V/m) ²	DCP Z	98	mV

Sensitivity in Tissue Simulating Liquid

Head	900 MHz	$\varepsilon_r = 41.5 \pm 5\%$	σ = 0.97 ± 5% mho/m	
Head	835 MHz	$\varepsilon_r = 41.5 \pm 5\%$	σ = 0.90 ± 5% mho/m	
	ConvF X	7.0 ± 9.5% (k=2)	Boundary effect:	
	ConvF Y	7.0 ± 9.5% (k=2)	Alpha 0.30	
	ConvF Z	7.0 ± 9.5% (k=2)	Depth 2.51	
Head	1800 MHz	$\varepsilon_r = 40.0 \pm 5\%$	σ = 1.40 ± 5% mho/m	
Head	1900 MHz	$\varepsilon_r = 40.0 \pm 5\%$	σ = 1.40 ± 5% mho/m	
	ConvF X	5.4 ± 9.5% (k=2)	Boundary effect:	
	ConvF Y	5.4 ± 9.5% (k=2)	Alpha 0.45	
	ConvF Z	5.4 ± 9.5% (k=2)	Depth 2.30	

Boundary Effect

Head	900	MHz	Typical SAR gradie	nt: 5 % per mm		
	Probe Tip to	o Bounda	ry	1 n	nm 2 mm	
	SAR _{be} [%]	Without	Correction Algorithm	7.6	6 4.3	
	SAR _{be} [%]	With Co	rrection Algorithm	0.3	0.5	
Head	1800	MHz	Typical SAR gradie	nt: 10 % per mm		
	Probe Tip to	o Bounda	ry	1 n	nm 2 mm	
	SAR _{be} [%]	Without	Correction Algorithm	9.7	6.6	
	SAR _{be} [%]	With Co	rrection Algorithm	0.2	2 0.3	
Sensor	Offset					
	Probe Tip to	o Sensor	Center	2.7	mm	
	Optical Sur	face Dete	ection	1.9 ± 0.2	mm	

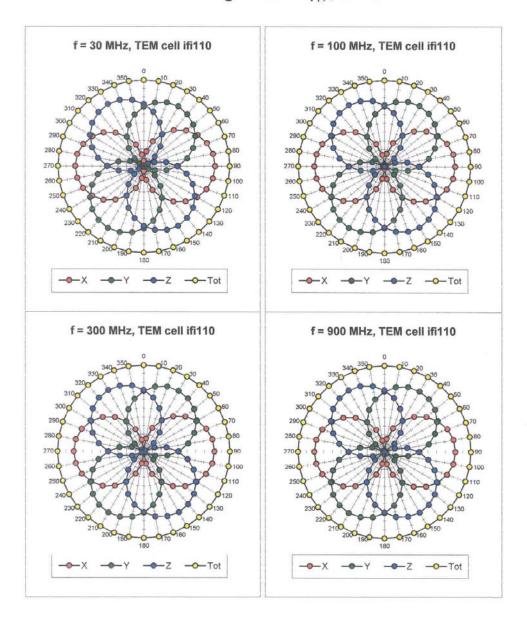
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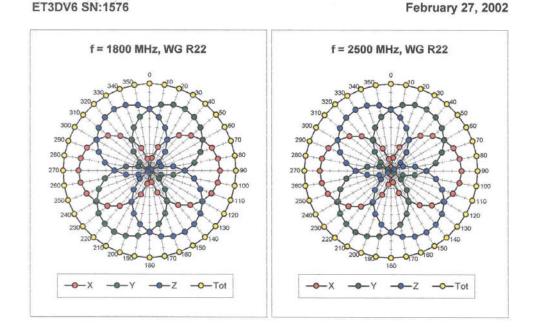


Receiving Pattern (ϕ), $\theta = 0^{\circ}$

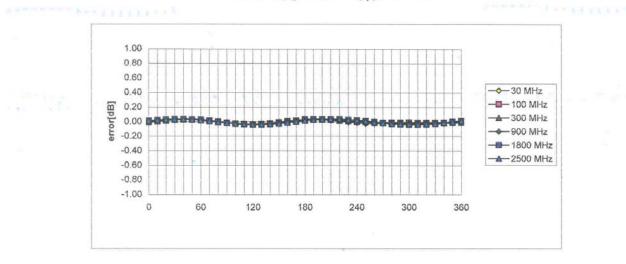
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Isotropy Error (ϕ), $\theta = 0^{\circ}$



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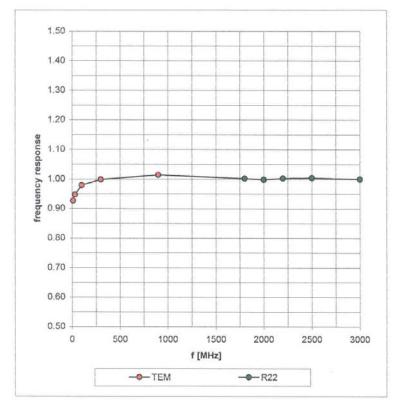


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Frequency Response of E-Field



(TEM-Cell:ifi110, Waveguide R22)

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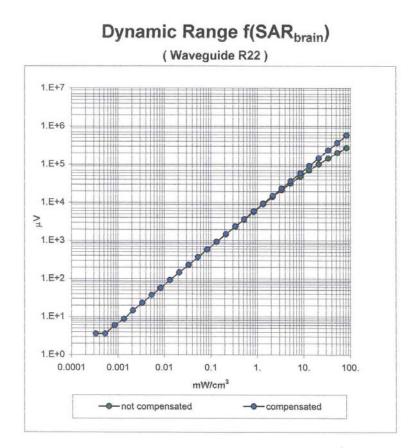
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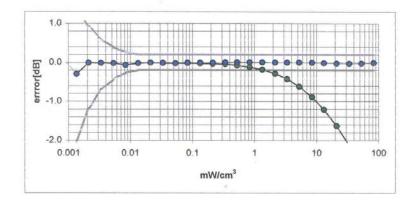


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ET3DV6 SN:1576

February 27, 2002





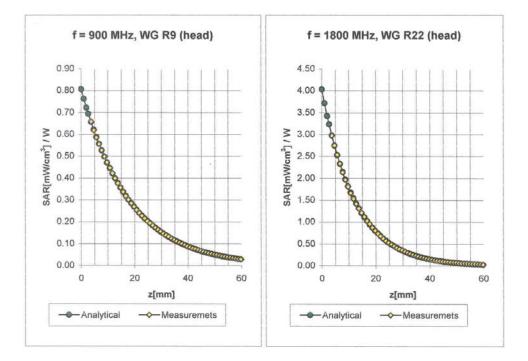
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Conversion Factor Assessment

Head	900 MHz	$\varepsilon_r = 41.5 \pm 5\%$	σ = 0.97 ± 5% mho/m	
Head	835 MHz	ε _r = 41.5 ± 5%	σ = 0.90 ± 5% mho/m	
	ConvF X	7.0 ± 9.5% (k=2)	Boundary effect:	
	ConvF Y	7.0 ± 9.5% (k=2)	Alpha 0.30	
	ConvF Z	7.0 ± 9.5% (k=2)	Depth 2.51	

Head	1800 MHz	ϵ_r = 40.0 ± 5%	σ = 1.40 ± 5% mho/m	
Head	1900 MHz	$\epsilon_r = 40.0 \pm 5\%$	σ = 1.40 ± 5% mho/m	
	ConvF X	5.4 ± 9.5% (k=2)	Boundary effect:	
	ConvF Y	5.4 ± 9.5% (k=2)	Alpha 0.45	
	ConvF Z	5.4 ± 9.5% (k=2)	Depth 2.30	

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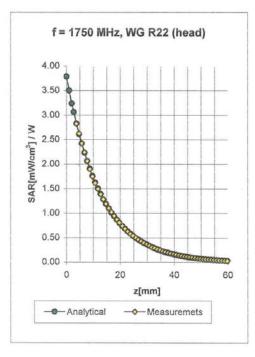


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Conversion Factor Assessment



Head	1750 MH	$\epsilon_r = 40.0 \pm 5\%$	σ = 1.40 ± 5% mho/m	
	ConvF X	5.4 ± 8.9% (k=2)	Boundary ef	fect:
	ConvF Y	5.4 ± 8.9% (k=2)	Alpha	0.45
	ConvF Z	5.4 ± 8.9% (k=2)	Depth	2.27

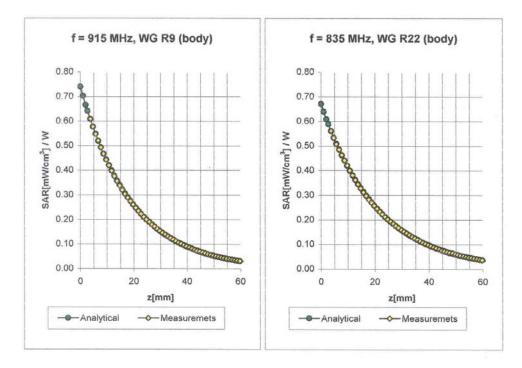
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Conversion Factor Assessment

915 MHz		$\varepsilon_r = 55.0 \pm 5\%$	σ = 1.06 ± 5% mho/m	
ConvF X	6.7 :	± 8.9% (k=2)	Boundary eff	ect:
ConvF Y	6.7	± 8.9% (k=2)	Alpha	0.45
ConvF Z	6.7 :	± 8.9% (k=2)	Depth	2.01
835 MHz		$\epsilon_r = 55.2 \pm 5\%$	σ = 0.97 ± 5% m	ho/m
ConvF X	6.7	± 8.9% (k=2)	Boundary eff	iect:
ConvF Y	6.7	± 8.9% (k=2)	Alpha	0.34
ConvF Z	6.7	± 8.9% (k=2)	Depth	2.37
	ConvF X ConvF Y ConvF Z 835 MHz ConvF X ConvF Y	ConvF X 6.7 ConvF Y 6.7 ConvF Z 6.7 835 MHz ConvF X 6.7 ConvF Y 6.7	ConvF X 6.7 \pm 8.9% (k=2)ConvF Y 6.7 \pm 8.9% (k=2)ConvF Z 6.7 \pm 8.9% (k=2)835 MHz $\epsilon_r = 55.2 \pm 5\%$ ConvF X 6.7 \pm 8.9% (k=2)ConvF Y 6.7 \pm 8.9% (k=2)	ConvF X 6.7 $\pm 8.9\%$ (k=2) Boundary eff ConvF Y 6.7 $\pm 8.9\%$ (k=2) Alpha ConvF Z 6.7 $\pm 8.9\%$ (k=2) Depth 835 MHz $\epsilon_r = 55.2 \pm 5\%$ $\sigma = 0.97 \pm 5\%$ m ConvF X 6.7 $\pm 8.9\%$ (k=2) Boundary eff ConvF X 6.7 $\pm 8.9\%$ (k=2) Boundary eff ConvF Y 6.7 $\pm 8.9\%$ (k=2) Boundary eff

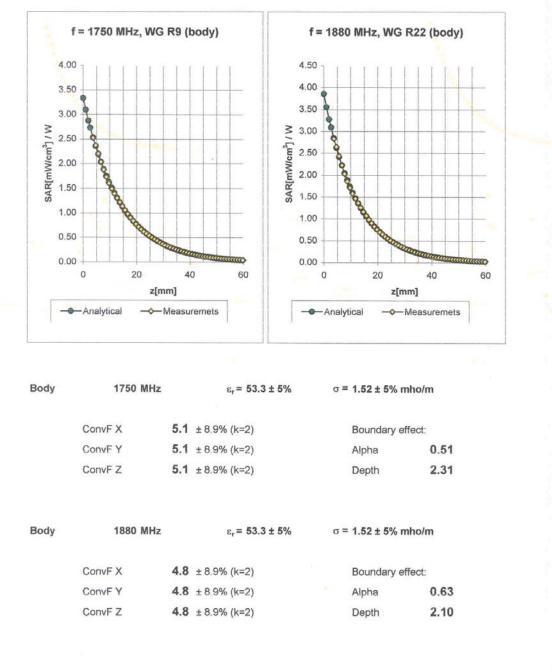
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Conversion Factor Assessment

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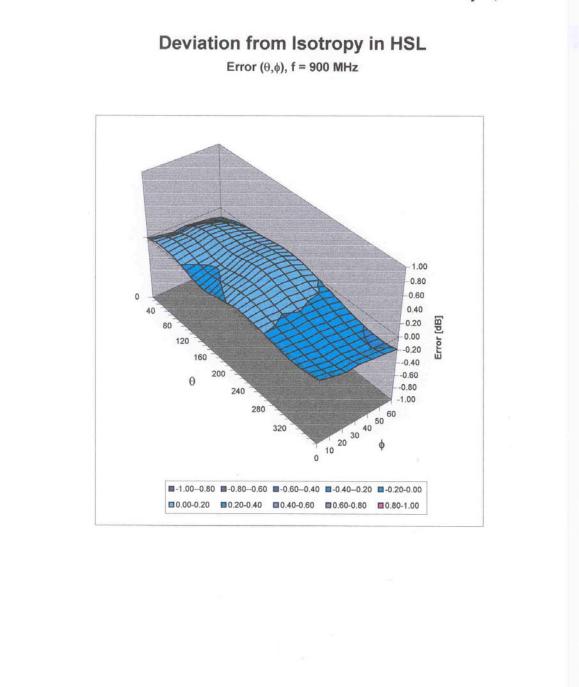


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Date of Test: April 14 to 17, 2003

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Telson Electronics USA, Inc., Model No: TDC-8200 FCC ID: MC6TDC8200

Date of Test: April 14 to 17, 2003

APPENDIX C – Phantom Certificate

Schmid & Partner Engineering AG Zeughausstrasse 43, 8004 Zurich, Switzerland, Phone +41 1 245 97 00, Fax +41 1 245 97 79 Certificate of conformity / First Article Inspection SAM Twin Phantom V4.0 Item QD 000 P40 BA Type No Series No TP-1002 and higher Manufacturer / Origin Untersee Composites Hauptstr. 69 CH-8559 Fruthwilen Switzerland Tests The series production process used allows the limitation to test of first articles Complete tests were made on the pre-series Type No. QD 000 P40 AA, Serial No. TP-1001 and on the series first article Type No. QD 000 P40 BA, Serial No. TP-1006. Certain parameters have been retested using further series units (called samples). Requirement Test Details Units tested Compliance with the geometry Shape IT'IS CAD File (*) First article. according to the CAD model. Samples Material thickness Compliant with the requirements 2mm +/- 0.2mm in First article. according to the standards specific areas Samples Material 200 MHz - 3 GHz Dielectric parameters for required Material frequencies parameters Relative permittivity < 5 sample Loss tangent < 0.05 TP 104-5 Material resistivity The material has been tested to be Liquid type HSL 1800 Pre-series, compatible with the liquids defined in and others according to First article the standards the standard. Standards CENELEC EN 50361 IEEE P1528-200x draft 6.5 [3] IEC PT 62209 draft 0.9 The IT'IS CAD file is derived from [2] and is also within the tolerance requirements of the shapes of (*) [1] and [3]. Conformity Based on the sample tests above, we certify that this item is in compliance with the uncertainty requirements of SAR measurements specified in standard [1] and draft standards [2] and [3]. Date 18.11.2001 Signature / Stamp Doc No 881 - QD 000 P40 BA - B Page 1 (1)